Compact, Isolated, Half-Duplex RS-485/RS-422 Transceivers with AutoDirection Control

General Description

The MAX22025-MAX22028 compact isolated RS-485/RS-422 transceivers provide 3.5kV_{RMS} of digital galvanic isolation between the cable-side (RS-485/RS-422 driver/receiver-side) and the UART-side of the device. Isolation improves communication by breaking ground loops and reduces noise when there are large differences in ground potential between ports. These devices allow for robust communication up to 0.5Mbps or 16Mbps.

The MAX22025-MAX22028 feature Maxim's proprietary AutoDirection control making these devices ideal for applications such as isolated RS-485 ports, where the driver input is used in conjuction with the driver-enable signal to drive the differential bus.

The MAX22025/MAX22027 feature reduced slew rate drivers that minimize EMI and reduce reflections caused by improper termination of cable allowing error-free transmission up to 0.5Mbps. The MAX22026/MAX22028 driver outputs are not slew-rate limited, allowing transmit speeds up to 16Mbps.

The receiver output of the MAX22025/MAX22026 does not follow (VA-VB) when the device is in the driver-enabled state. The receiver output on the MAX22027/MAX22028 always follows (VA-VB).

The driver outputs and receiver inputs are protected from ±10kV electrostatic discharge (ESD) to GNDB on the cable side, as specified by the Human Body Model (HBM). The MAX22025-MAX22028 are available in a compact 8-pin wide body SOIC package and operate over the -40°C to +85°C temperature range.

Applications

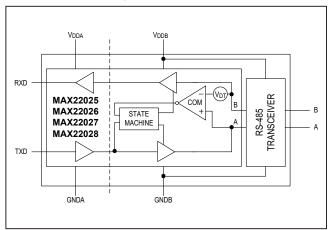
- Utility Meters
- Industrial Automation Equipment
- Programmable Logic Controllers
- HVAC

Benefits and Features

- High-Level Integration Reduces Overall Solution Size
 - Fully Isolated Half-Duplex RS-485/RS-422 Transceivers
 - Compact 8-Pin Wide Body SOIC Package (5.5mm Creepage)
- Integrated Protection Ensures Robust Communication
 - ±10kV ESD (HBM) on Driver Outputs/Receiver Inputs
 - Withstands 3.5kV_{RMS} Isolation Voltage for 60 Seconds (V_{ISO})
 - Withstands 630VPEAK Maximum Repetitive Peak-Isolation Voltage (V_{IORM})
 - Continuously Withstands 445V_{RMS} Maximum Working-Isolation Voltage (V_{IOWM})
- Enables Flexible System Design
 - 0.5Mbps Maximum Data Rate with Slew-Rate Limited Driver (MAX22025/MAX22027)
 - 16Mbps Maximum Data Rate (MAX22026/MAX22028)
 - AutoDirection Eliminates the Need for DE and RE Control Signals

Ordering Information appears at end of data sheet.

Functional Diagram





Compact, Isolated, Half-Duplex RS-485/RS-422 Transceivers with AutoDirection Control

Absolute Maximum Ratings

V _{DDA} , TXD to GNDA0.3\	V to +6V	Continuous Power Dissipation ($T_A = +70$ °C)	
V _{DDB} to GNDB0.3\	V to +6V	8-pin Wide SOIC (derate 23mW/°C above	+70°C)1847mW
RXD to GNDA0.3V to (V _{DDA}	+ 0.3V)	Operating Temperature Range	40°C to +85°C
A, B to GNDB8V	to +13V	Junction Temperature	+150°C
Short Circuit Duration (RXD to GNDA)Co	ntinuous	Storage Temperature Range	65°C to +150°C
Short Circuit Duration (A, B to GNDB)Co	ntinuous	Lead Temperature (soldering, 10s)	+300°C
		Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

PACKAGE TYPE: 8 Wide SOIC				
Package Code	W8MS+1			
Outline Number	21-0262			
Land Pattern Number	90-0258			
THERMAL RESISTANCE, FOUR-LAYER BOARD				
Junction to Ambient (θ _{JA})	43.3°C/W			
Junction to Case (θ_{JC})	36.5°C/W			

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

DC Electrical Characteristics

 $(V_{DDA}-V_{GNDA}=1.71V\ to\ 5.5V,\ V_{DDB}-V_{GNDB}=4.75V\ to\ 5.25V,\ T_{A}=T_{MIN}\ to\ T_{MAX},\ unless\ otherwise\ noted.$ Typical values are at $V_{DDA}-V_{GNDA}=3.3V,\ V_{DDB}-V_{GNDB}=5V,\ V_{GNDA}=V_{GNDB},\ and\ T_{A}=+25^{\circ}C.)\ (Notes\ 1,\ 2)$

PARAMETER	SYMBOL	C	ONDITIONS	MIN	TYP	MAX	UNITS	
POWER								
Cumply Valtage	V _{DDA}	1.71 4.75			5.5	V		
Supply Voltage	V _{DDB}			4.75		5.25	V	
Supply Current	I _{DDA}		V _{DDA} = 3.3V, RXD is unconnected, TXD = low, no bus load		0.39	0.7	mA	
Зирріу Сипені	I _{DDB}	V _{DDB} = 5V, RXI TXD = low, no b		4.0	5.5	IIIA		
V _{DDA} Undervoltage Lockout Threshold	V _{UVLOA}	V _{DDA} rising		1.5	1.6	1.66	V	
V _{DDA} Undervoltage Lockout Threshold Hysteresis	V _{UVHYSTA}				45		mV	
LOGIC INTERFACE (TXD, RXI	LOGIC INTERFACE (TXD, RXD)							
Input High Voltage	ltage V _{IH} TXD to	TVD (ONDA	2.25V ≤ V _{DDA} ≤ 5.5V	0.7 x V _{DDA}			V	
Input High Voltage		TXD to GNDA	1.71V ≤ V _{DDA} < 2.25V					

DC Electrical Characteristics (continued)

 $(V_{DDA}-V_{GNDA}=1.71V\ to\ 5.5V,\ V_{DDB}-V_{GNDB}=4.75V\ to\ 5.25V,\ T_{A}=T_{MIN}\ to\ T_{MAX},\ unless\ otherwise\ noted.$ Typical values are at $V_{DDA}-V_{GNDA}=3.3V,\ V_{DDB}-V_{GNDB}=5V,\ V_{GNDA}=V_{GNDB},\ and\ T_{A}=+25^{\circ}C.)\ (Notes\ 1,\ 2)$

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	TYP	MAX	UNITS	
In 4 I \ / - I4	\ /	TVD to CNDA	$2.25V \le V_{DDA} \le 5.5V$			8.0	\ /	
Input Low Voltage	V_{IL}	TXD to GNDA $1.71V \le V_{DDA} < 2.25V$				0.7	V	
Input Hysteresis	V_{HYS}	TXD to GNDA			410		mV	
Input Capacitance	C _{IN}	TXD, f = 1MHz			2		pF	
Input Pullup Current	I _{PU}	TXD		-10	-5	-1.5	μA	
Output Voltage High	V _{OH}	RXD to GNDA, I	OUT = -4mA	V _{DDA} -0.4			V	
Output Voltage Low	V _{OL}	RXD to GNDA, I	OUT = 4mA			0.4	V	
DRIVER								
		R _L = 100Ω, TXD	= low, Figure 1a	2.0		V_{DDB}		
Differential Driver Output	V _{OD}	$R_L = 54\Omega$, TXD =	low, Figure 1a	1.5		V _{DDB}	V	
		-7V ≤ V _{CM} ≤ +12	2V, TXD = low, Figure 1b	1.5		5		
Driver Common-Mode Output Voltage	V _{OC}	$R_L = 100\Omega \text{ or } 54$	Ω, TXD = low, Figure 1a		V _{DDB} /2	3	V	
Driver Disable Threshold	V_{DT}	TXD = low to hig	h (Note 3)	0.6		1	V	
Driver Short-Circuit Output	loop	GNDB ≤ V _{OUT} ≤	+12V, output low	+50		+250	mA	
Current	losd	-7V ≤ V _{OUT} ≤ V _{DDB} , output high		-250		-50	ША	
Driver Short-Circuit Foldback	lou	$(V_{DDB}-1V) \le V_{OUT} \le +12V$, output low -7V $\le V_{OUT} \le V_{DDB}$, output high		+20			mA	
Output Current	I _{SH}					-20	111/3	
RECEIVER								
Input Current (A and B)	la la	I _A , I _B	V _{DDB} = GNDB o				+250	μA
input Guitent (A and B)	'A, 'B	5V, receive state	V _{IN} = -7V	-200			μΑ	
Receiver Differential Threshold Voltage	V_{TH}	-7V ≤ V _{CM} ≤ +12	2V	-200		+200	mV	
Receiver Input Hysteresis	ΔV_{TH}	V _{CM} = 0V			25		mV	
Receiver Input Resistance	R _{IN}	-7V ≤ V _{CM} ≤ +12	2V, Receive state		60		kΩ	
THERMAL SHUTDOWN								
Thermal Shutdown Threshold	T _{SHDN}	Temperature risi	ng		+135		°C	
Thermal Shutdown Hysteresis	T _{SHDN} _ HYS				20		°C	
PROTECTION								
ESD Protection (A and B Pins to GNDB)		Human Body Mo	odel		±10		kV	
ESD Protection (A and B Pins to GNDA) with 47pF Capacitor Connected between GNDA and GNDB		Human Body Mo	odel		±7		kV	
ESD Protection (All Other Pins)		Human Body Mo	odel		±4		kV	
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Switching Electrical Characteristics (MAX22025/MAX22027)

 $(V_{DDA}-V_{GNDA}=1.71V\ to\ 5.5V,\ V_{DDB}-V_{GNDB}=4.75V\ to\ 5.25V,\ T_{A}=T_{MIN}\ to\ T_{MAX},\ unless\ otherwise\ noted.$ Typical values are at $V_{DDA}-V_{GNDA}=3.3V,\ V_{DDB}-V_{GNDB}=5V,\ V_{GNDA}=V_{GNDB},\ and\ T_{A}=+25^{\circ}C.)\ (Notes\ 1,\ 2)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Common Mode Transient Immunity	CMTI	(Note 5)		50		kV/μs
DRIVER						
Driver Propagation Delay	^t DPLH, ^t DPHL	R_L = 110 Ω , C_L = 50pF, Figure 2 and Figure 3 (Note 4)	200		1000	ns
Driver Differential Output Rise or Fall Time	t _{LH} , t _{HL}	R_L = 110 Ω , C_L = 50pF, Figure 2 and Figure 3 (Note 4)	200		900	ns
Maximum Data Rate	DR _{MAX}		0.5			Mbps
Driver Enable from Power Up	t _{PORD}			100	150	μs
RECEIVER						
Receiver Propagation Delay	t _{RPLH} , t _{RPHL}	C _L = 15pF, Figure 4 and Figure 5 (Note 4)			80	ns
Receiver Output Skew t _{RPLH} - t _{RPHL}	t _{RSKEW}	C _L = 15pF, Figure 5 (Note 4)			13	ns
Maximum Data Rate	DR _{MAX}		16			Mbps
Receiver Enable from Power Up	t _{PORR}			100	150	μs

Switching Electrical Characteristics (MAX22026/MAX22028)

 $(V_{DDA}-V_{GNDA}=1.71V\ to\ 5.5V,\ V_{DDB}-V_{GNDB}=4.75V\ to\ 5.25V,\ T_{A}=T_{MIN}\ to\ T_{MAX},\ unless\ otherwise\ noted.$ Typical values are at $V_{DDA}-V_{GNDA}=3.3V,\ V_{DDB}-V_{GNDB}=5V,\ V_{GNDA}=V_{GNDB},\ and\ T_{A}=+25^{\circ}C.)\ (Notes\ 1,\ 2)$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Common Mode Transient Immunity	CMTI	(Note 5)		50		kV/µs
DRIVER						
Driver Propagation Delay	t _{DPLH} , t _{DPHL}	R_L = 110 Ω , C_L = 50pF, Figure 2 and Figure 3 (Note 4)			50	ns
Driver Differential Output Rise or Fall Time	t _{LH} , t _{HL}	R_L = 110 Ω , C_L = 50pF, Figure 2 and Figure 3 (Note 4)			15	ns
Maximum Data Rate	DR _{MAX}		16			Mbps
Driver Enable from Power Up	t _{PORD}			100	150	μs
RECEIVER						
Receiver Propagation Delay	t _{RPLH} , t _{RPHL}	C _L = 15pF, Figure 4 and Figure 5 (Note 4)			80	ns
Receiver Output Skew t _{RPLH} - t _{RPHL}	t _{RSKEW}	C _L = 15pF, Figure 5 (Note 4)			13	ns
Maximum Data Rate	DR _{MAX}		16			Mbps
Receiver Enable from Power Up	t _{PORR}			100	150	μs

- **Note 1:** All devices are 100% production tested at $T_A = +85$ °C. Specifications over temperature are guaranteed by design.
- **Note 2:** All currents into the device are positive. All currents out of the device are negative. All voltages are referenced to their respective ground (GNDA or GNDB), unless otherwise noted.
- Note 3: This is the differential voltage from A to B that the driving device must see on the bus to disable its driver.
- **Note 4:** Not production tested. Guaranteed by design.
- Note 5: CMTI is the maximum sustainable common-mode voltage slew rate while maintaining the correct output states. CMTI applies to both rising and falling common-mode voltage edges. Tested with the transient generator connected between GNDA and GNDB. V_{CM} = 1kV

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Insulation Characteristics

PARAMETER	SYMBOL	CONDITIONS	VALUE	UNITS
Maximum Repetitive Peak Withstand Voltage	VIORM	(Note 6)	630	VP
Maximum Working Isolation Voltage	VIOWM	GNDA to GNDB continuous (Note 6)	445	VRMS
Maximum Transient Isolation Voltage	VIOTM		5000	VP
Maximum Withstand Isolation Voltage	VISO	GNDA to GNDB for 60s (Note 7)	3500	VRMS
Maximum Surge Isolation Voltage	VIOSM	Basic Insulation, 1.2/50µs pulse per IEC61000-4-5	10	kV
Insulation Resistance	R _S	T _A = +150°C, V _{IO} = 500V	>109	Ω
Barrier Capacitance Side A to Side B	CIO	GNDA to GNDB	2	pF
Minimum Creepage Distance	CPG		5.5	mm
Minimum Clearance Distance	CLR		5.5	mm
Internal Clearance		Distance through insulation	0.015	mm
Comparitive Tracking Resistance Index	СТІ		>400	
Climatic Category			40/125/21	
Pollution Degree			2	

Note 6: V_{IORM} , V_{IOWM} , and V_{ISO} are defined by the IEC 60747-5-5 standard. Note 7: Product is qualified at V_{ISO} for 60 seconds. Not production tested.

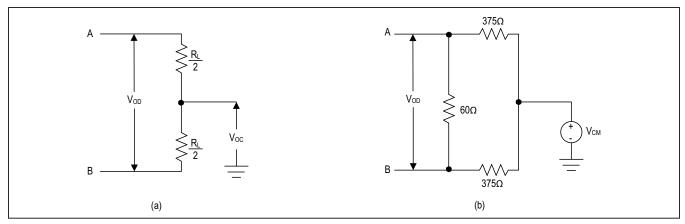


Figure 1. Driver DC Test Load

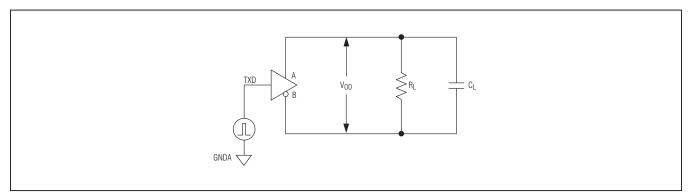


Figure 2. Driver Timing Test Circuit

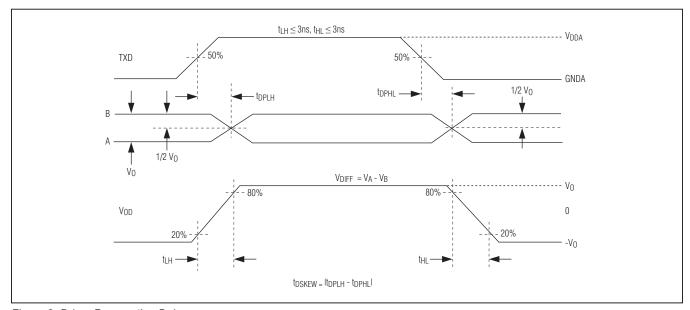


Figure 3. Driver Propagation Delays

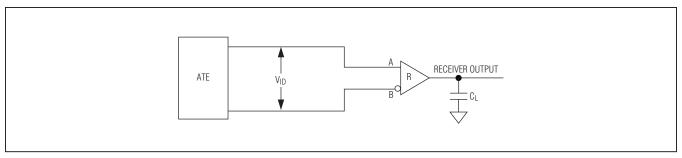


Figure 4. Receiver Propagation Delay Test Circuit

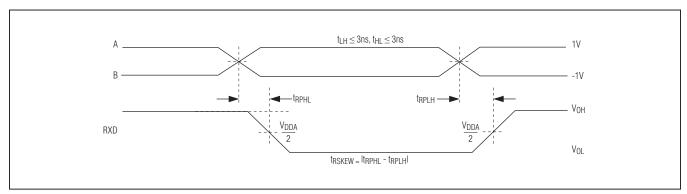
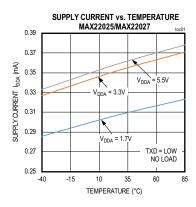
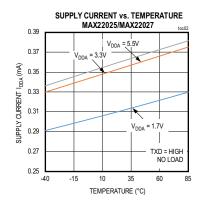


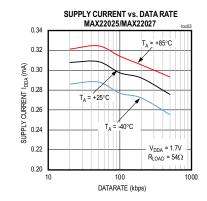
Figure 5. Receiver Propagation Delays

Typical Operating Characteristics

 $(V_{DDA} - V_{GNDA} = 3.3V, V_{DDB} - V_{GNDB} = 5V, V_{GNDA} = V_{GNDB}, and T_{A} = +25$ °C, unless otherwise noted.)

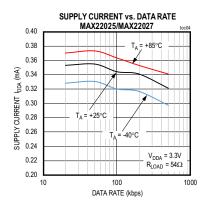


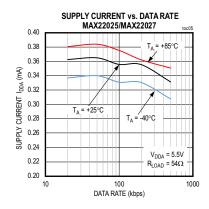


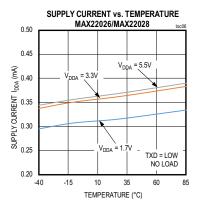


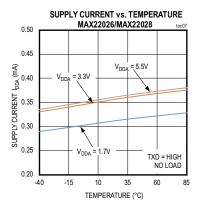
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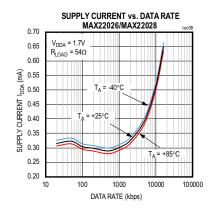
 $(V_{DDA} - V_{GNDA} = 3.3V, V_{DDB} - V_{GNDB} = 5V, V_{GNDA} = V_{GNDB}, and T_A = +25$ °C, unless otherwise noted.)

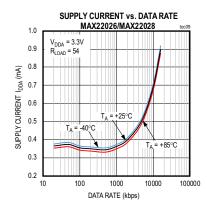


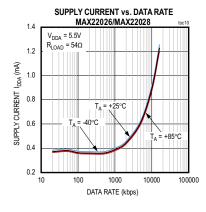


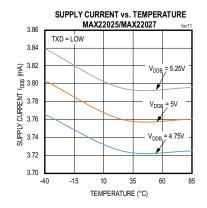


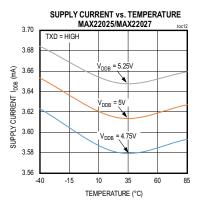






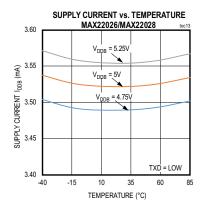


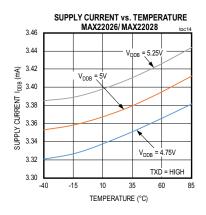


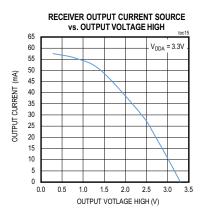


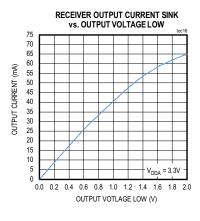
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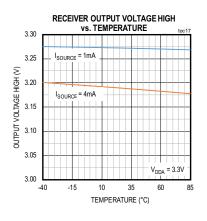
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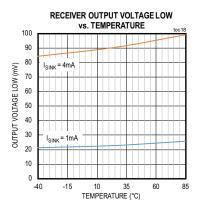


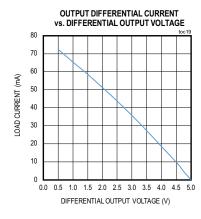


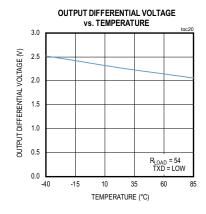


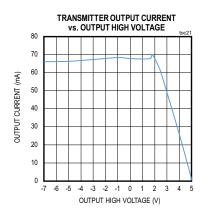






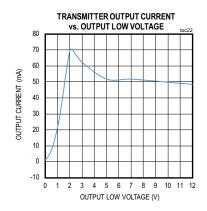


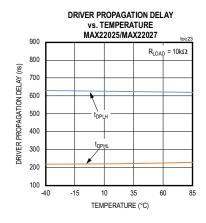


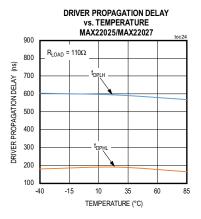


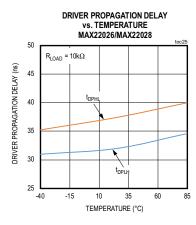
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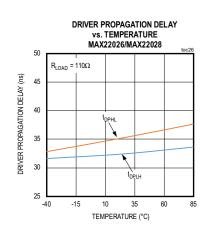
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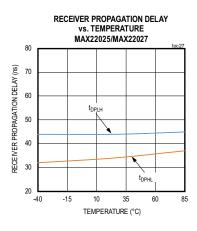


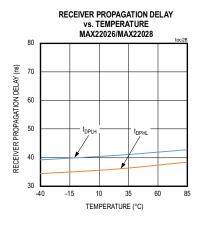




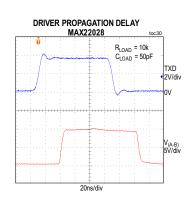






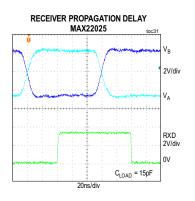


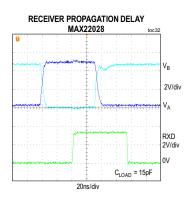




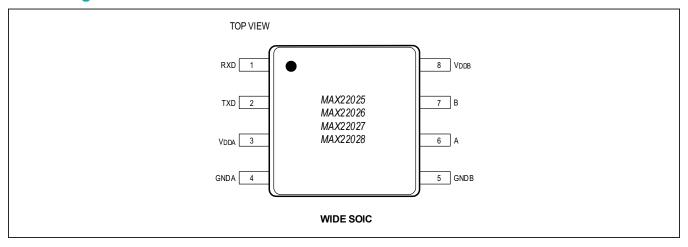
Typical Operating Characteristics (continued)

 $(V_{DDA} - V_{GNDA} = 3.3V, V_{DDB} - V_{GNDB} = 5V, V_{GNDA} = V_{GNDB}, and T_A = +25$ °C, unless otherwise noted.)





Pin Configuration



Pinibes	o PMM/S	REFERENCE	FUNCTION
1	RXD	GNDA	Receiver Data Output. See the <i>Function Tables</i> for more information.
2	TXD	GNDA	Driver Input. TXD is the input to the internal state machine that automatically enables and disables the driver. See the <i>Function Tables</i> and <i>AutoDirection Circuitry</i> sections for more information. TXD has an internal 5µA pullup to V _{DDA} .
3	V_{DDA}	GNDA	UART/Logic-Side Power Input. Bypass V_{DDA} to GNDA with both $0.1\mu F$ and $1\mu F$ capacitors as close to the device as possible.
4	GNDA	-	UART/Logic-Side Ground. GNDA is the ground reference for digital signals.
5	GNDB	-	Cable Side Ground. GNDB is the ground reference for the RS-485/RS-422 bus signals.
6	Α	GNDB	Noninverting Driver Output/Receiver Input
7	В	GNDB	Inverting Driver Output/Receiver Input
8	V_{DDB}	GNDB	Cable Side Power Input. Bypass $V_{\mbox{DDB}}$ to GNDB with both 0.1 $\mu \mbox{F}$ and 1 $\mu \mbox{F}$ capacitors as close to the device as possible.

Function Tables

	TRANSMIT FUNCTIONALITY						
TXD	(V _A - V _B) PREVIOUS STATE CURRENT STATE A						
0	X	X	Driver Enabled	0	1		
1	$(V_A - V_B) \ge V_{DT}$	X	Receiver Enabled	High-Z	High-Z		
1	()/.	Driver Enabled	Driver Enabled	1	0		
'	(V _A - V _B) < V _{DT}	Receiver Enabled	Receiver Enabled	High-Z	High-Z		

X = Don't care

RXD FUNCTIONALITY						
CURRENT STATE	(V. Va)	RXD				
CORRENT STATE	(V _A - V _B)	MAX22025/MAX22026	MAX22027/MAX22028			
Receiver Enabled	$(V_A - V_B) \ge +200 \text{mV}$	1	1			
	(V _A - V _B) ≤ -200mV	0	0			
Driver Enghlad	(V _A - V _B) ≥ +200mV	1	1			
Driver Enabled	(V _A - V _B) ≤ -200mV	1	0			

Detailed Description

The MAX22025-MAX22028 isolated RS-485/RS-422 transceivers provide 3500V_{RMS} (60s) of galvanic isolation between the RS-485/RS-422 cable side of the transceiver and the UART side. These devices allow up to 0.5Mbps (MAX22025/MAX22027) or 16Mbps (MAX22026/MAX22028) communication across an isolation barrier when a large potential exists between grounds on each side of the barrier.

Isolation

Data isolation is achieved using high-voltage capacitors that allow data transmission between the UART side and the RS-485/RS-422 cable side of the transceiver.

AutoDirection Circuitry

Internal circuitry in the MAX22025-MAX22028, in conjunction with an external pullup resistor on A and pulldown resistor on B (see Typical Application Circuit), acts to automatically disable or enable the driver and the receiver to keep the bus in the correct state. This AutoDirection circuitry consists of a state machine and an additional

receive comparator that determine whether this device is trying to drive the bus or another node on the network is driving the bus.

The internal state machine has two inputs:

- TXD
- The current state of (V_A-V_B), which is determined by a dedicated differential comparator.

The state machine also has two outputs:

- DRIVER_ENABLE—Internal signal that enables and disables the driver
- RECEIVER_ENABLE—Internal signal that is the inverse of the DRIVER ENABLE signal.

When TXD is low, the device always drives the bus low. When TXD switches high, the device drives the bus for a short time, then disables the driver and allows the external pullup/pulldown resistors to hold the bus in the high state (V_A - $V_B \ge +200$ mV). During each low-to-high transition of TXD, the driver stays enabled until (V_A - V_B) \ge V_D T. The driver is then disabled and the pullup/pulldown resistors hold the A and B lines in the correct state.

Pullup and Pulldown Resistors

The pullup and pulldown resistors on the A and B lines are required for proper operation of the device although their exact value is not critical. They function to hold the bus in the high state (V_A - $V_B \ge +200$ mV) following a low-to-high transition. Sizing of these resistors is determined in the same way as when using any other RS-485 driver and depends on how the line is terminated and how many nodes are on the bus. The most important factor when sizing these resistors is to guarantee that the idle voltage on the bus (V_A - V_B) is greater than 200mV in order to remain compatible with standard RS-485 receiver thresholds.

Receive State

When not transmitting data, the MAX22025-MAX22028 require the TXD input be high to remain in the receive state. A conventional RS-485 transceiver has DE and RE inputs that are used to enable and disable the driver and receiver. However, the MAX22025-MAX22028 do not have a DE input, and instead use an internal state machine to enable and disable the drivers.

Receiver Output (RXD)

The receiver output (RXD) of the MAX22025/MAX22026 does not follow TXD when the device is in the driver-enabled state. This allows for line interference detection by verifying that RXD remains high throughout data transmission.

On the MAX22027/MAX22028, the receiver output (RXD) always follows (V_A-V_B).

ESD Protection

ESD protection structures are incorporated on all pins to protect against electrostatic discharge encountered during handling and assembly. The driver outputs and receiver inputs of the devices have extra protection against static electricity to both the UART side and cable side ground references. The ESD structures withstand high-ESD events during normal operation and when powered down. After an ESD event, the devices keep working without latch-up or damage.

Bypass V_{DDA} to GNDA and bypass V_{DDB} to GNDB with 0.1µF and 1µF capacitors to ensure maximum ESD protection.

ESD Test Conditions

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

Human Body Model (HBM)

<u>Figure 6</u> shows the HBM test model, while <u>Figure 7</u> shows the current waveform it generates when discharged in a low-impedance state. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a $1.5 \text{k}\Omega$ resistor.

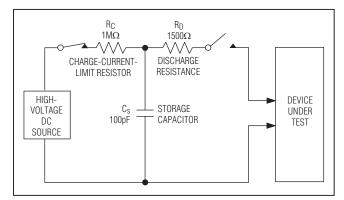


Figure 6. Human Body ESD Test Model

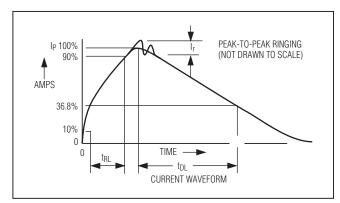
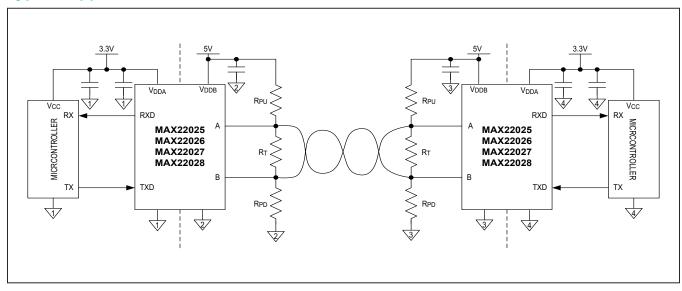
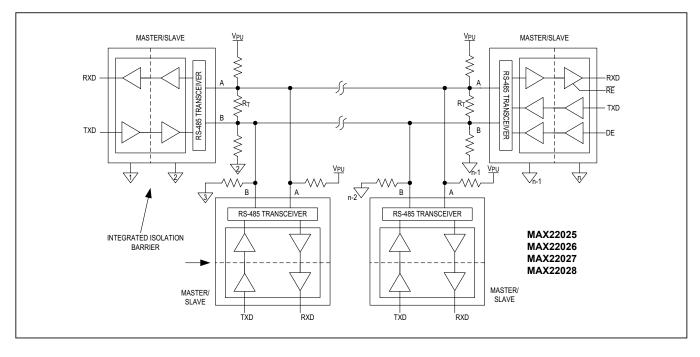


Figure 7. Human Body Current Waveform

Typical Application Circuits





Ordering Information

PART	TEMP RANGE	RXD IN DRIVER-ENABLED STATE	DRIVER SPEED (Mbps)	PIN-PACKAGE
MAX22025AWA+	-40°C to +85°C	HIGH	0.5	8 Wide SOIC
MAX22025AWA+T	-40°C to +85°C	HIGH	0.5	8 Wide SOIC
MAX22026AWA+*	-40°C to +85°C	HIGH	16	8 Wide SOIC
MAX22026AWA+T*	-40°C to +85°C	HIGH	16	8 Wide SOIC
MAX22027AWA+*	-40°C to +85°C	FOLLOWS (V _A -V _B)	0.5	8 Wide SOIC
MAX22027AWA+T*	-40°C to +85°C	FOLLOWS (V _A -V _B)	0.5	8 Wide SOIC
MAX22028AWA+	-40°C to +85°C	FOLLOWS (V _A -V _B)	16	8 Wide SOIC
MAX22028AWA+T	-40°C to +85°C	FOLLOWS (V _A -V _B)	16	8 Wide SOIC

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

Chip Information

PROCESS: BICMOS

T = Tape and reel.

^{*}Future product—contact factory for availability.

Compact, Isolated, Half-Duplex RS-485/RS-422 Transceivers with AutoDirection Control

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/19	Initial release	_
1	9/19	Updated the <i>Electrical Characteristics</i> section and added future product designation to MAX22025AWA+ and MAX22025AWA+T in the <i>Ordering Information</i> section	3, 15
2	11/19	Removed future product designation from MAX22025AWA+ and MAX22025AWA+T in the <i>Ordering Information</i> section	15

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

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